

AMENDMENTS TO THE CLAIMS

1-12 (Canceled)

13-27 (Canceled)

28. (Previously Presented) A system comprising:
  - a first circuit board comprising a first electrical contact and a first connector;
  - a second circuit board comprising a second electrical contact and a second connector configured to be mated to the first connector, wherein when mated to each other, the first connector and the second connector provide a first connection for transmitting at least one signal between the first circuit board and the second circuit board; and
  - a pin header having at least one pin, the at least one pin passing through at least one hole in the first circuit board and at least one hole in the second circuit board, one of the at least one pins configured to make electrical contact with the first electrical contact and the second electrical contact, wherein the at least one pin is perpendicular to the first connection between the first connector and the second connector.
29. (Previously Presented) The system of claim 28, wherein the second connector is configured to be displaced along a first axis until the second connector is mated with the first connector; the first axis is perpendicular to a second axis; and the at least one pin extends along the second axis.
30. (Previously Presented) The system of claim 28, wherein when extended through the at least one hole in the first circuit board and the at least one hole in the second circuit board, the at least one pin provides a second connection for transmitting at least one signal between the first circuit board and the second circuit board.

31. (Previously Presented) The system of claim 30, wherein  
the first connection is an optical connection and a second connection is an electrical  
connection.
32. (Previously Presented) The system of claim 31, wherein  
the first connection transmits at least one optical signal between the first circuit board and  
the second circuit board, and  
the first connection transmits the at least one optical signal along a first axis.
33. (Previously Presented) The system of claim 32, wherein  
the second connection transmits at least one electrical signal between the first circuit  
board and the second circuit board, and  
the second connection transmits the at least one electrical signal along the second axis.
34. (Previously Presented) The system of claim 31, wherein  
the optical connection between the first connector and the second connector fixes the first  
circuit board and the second circuit board in at least a first plane.
35. (Previously Presented) The system of claim 34, wherein  
the second circuit board is an OC-192 transmit module.
36. (Previously Presented) The system of claim 31, wherein  
the second circuit board is disposed with zero interconnection height relative to the first  
circuit board.
37. (Previously Presented) The system of claim 28, further comprising:  
a pass-through socket, wherein  
the at least one pin passes through at least one hole in the pass-through socket.
38. (Previously Presented) The system of claim 37, further comprising:  
a second pass-through socket, wherein  
the at least one pin passes through at least one hole in the second pass-through socket.

39. (Previously Presented) The system of claim 38, wherein  
the pass-through socket is disposed on one side of a combination of the first circuit board  
and the second circuit board, and  
the second-pass through socket is disposed on an opposite side of the combination of the  
first circuit board and the second circuit board.

40. (Previously Presented) The system of claim 28, wherein  
electrical contact with the at least one pin is maintained by spring force of the first  
electrical contact and the second electrical contact.

41-45 (Canceled)

46. (Previously Presented) The system of claim 40, further comprising:  
a pass-through socket, wherein  
the means for inserting insert the one or more pins through at least one through-hole in  
the pass-through socket.

47. (Previously Presented) The system of claim 46, further comprising:  
a second pass-through socket, wherein  
the means for inserting insert the one or more pins through at least one hole in the second  
pass-through socket.

48. (Previously Presented) The system of claim 47, wherein  
the pass-through socket is disposed on one side of a combination of the first circuit board  
and the second circuit board, and  
the second-pass through socket is disposed on an opposite side of the combination of the  
first circuit board and the second circuit board.

49 – 62 (Canceled)